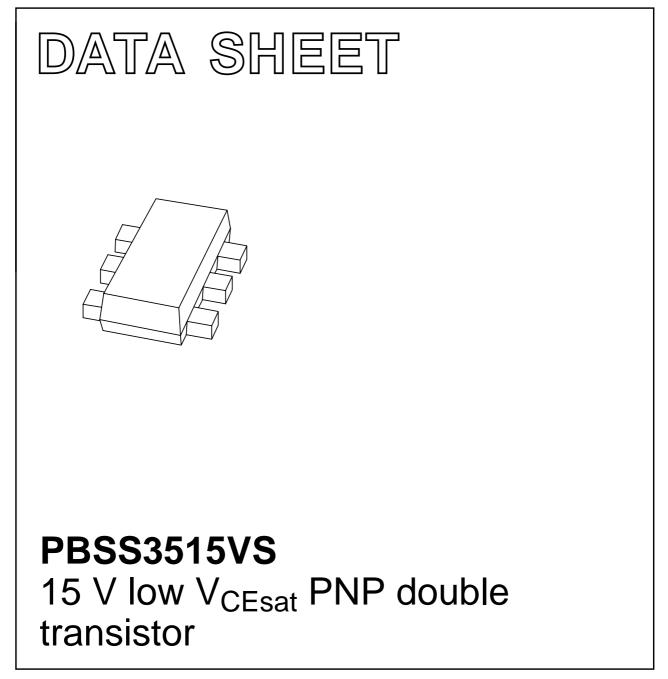
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2001 Sep 27

2001 Nov 07



15 V low V_{CEsat} PNP double transistor

FEATURES

- 300 mW total power dissipation
- Very small 1.6 x 1.2 mm ultra thin package
- · Self alignment during soldering due to straight leads
- · Low collector-emitter saturation voltage
- High current capability
- · Improved thermal behaviour due to flat leads
- Replaces two SC75/SC89 packaged low V_{CEsat} transistors on same PCB area
- Reduces required PCB area
- Reduced pick and place costs.

APPLICATIONS

- · General purpose switching and muting
- Low frequency driver circuits
- LCD backlighting
- Audio frequency general purpose amplifier applications
- Battery driven equipment (mobile phones, video cameras and hand-held devices).

DESCRIPTION

PNP low V_{CEsat} double transistor in a SOT666 plastic package. NPN complement: PBSS2515VS.

MARKING

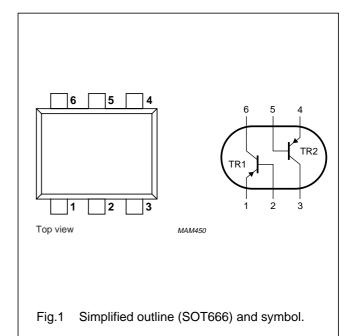
TYPE NUMBER	MARKING CODE		
PBSS3515VS	35		

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	–15	V
I _{CM}	peak collector current	-1	A
R _{CEsat}	equivalent on-resistance	<500	mΩ

PINNING

PIN	DESCRIPTION		
1, 4	emitter	TR1; TR2	
2, 5	base	TR1; TR2	
6, 3	collector	TR1; TR2	



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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transis	stor unless otherwise specified	·			
V _{CBO}	collector-base voltage	open emitter	-	-15	V
V _{CEO}	collector-emitter voltage	open base	-	-15	V
V _{EBO}	emitter-base voltage	open collector	_	-6	V
I _C	collector current (DC)		-	-500	mA
I _{CM}	peak collector current		-	-1	A
I _{BM}	peak base current		_	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	-	200	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	operating ambient temperature		65	+150	°C
Per device	9		•		
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	300	mW

Note

1. Transistor mounted on an FR4 printed-circuit board.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT	
R _{th j-a}	thermal resistance from junction to ambient	notes 1 and 2	416	K/W	

Notes

- 1. Transistor mounted on an FR4 printed-circuit board.
- 2. The only recommended soldering method is reflow soldering.

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CHARACTERISTICS

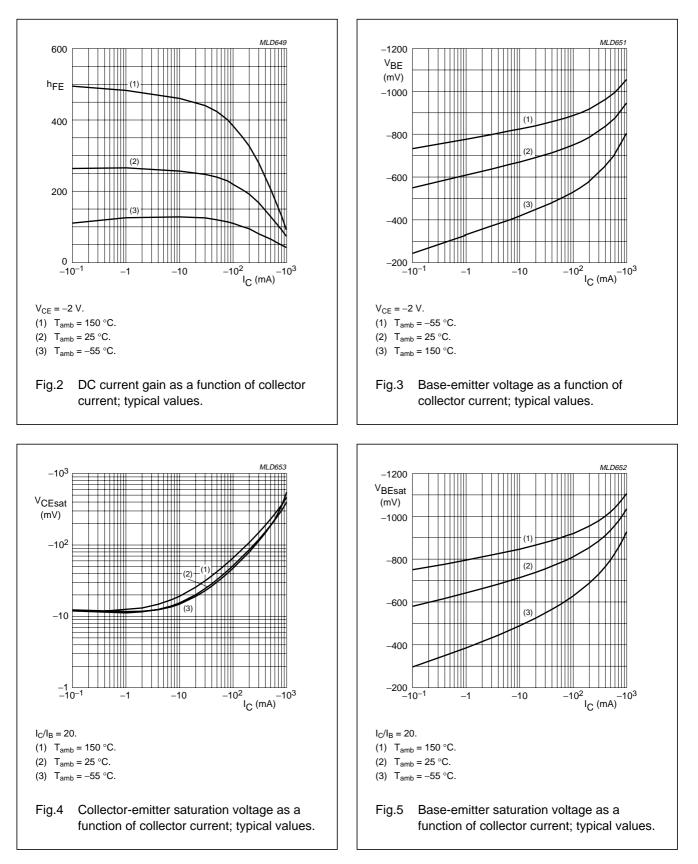
 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per transis	Per transistor unless otherwise specified					
I _{CBO}	collector-base cut-off current	$V_{CB} = -15 \text{ V}; I_E = 0$	-	-	-100	nA
		$V_{CB} = -15 \text{ V}; I_E = 0; T_j = 150 \text{ °C}$	-	-	-50	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0$	-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -10 \text{ mA}$	200	-	-	
		$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}; \text{ note } 1$	150	-	_	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -500 \text{ mA}; \text{ note } 1$	90	-	_	
V _{CEsat}	collector-emitter saturation	$I_{\rm C} = -10 \text{ mA}; I_{\rm B} = -0.5 \text{ mA}$	-	-	-25	mV
	voltage	$I_{\rm C} = -200 \text{ mA}; I_{\rm B} = -10 \text{ mA}$	-	-	-150	mV
		$I_{\rm C} = -500 \text{ mA}; I_{\rm B} = -50 \text{ mA}; \text{ note } 1$	-	-	-250	mV
R _{CEsat}	equivalent on-resistance	$I_{\rm C} = -500 \text{ mA}; I_{\rm B} = -50 \text{ mA}; \text{ note } 1$	-	300	<500	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}; \text{ note } 1$	-	-	-1.1	V
V _{BE}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -100 \text{ mA}; \text{ note } 1$	-	-	-0.9	V
f _T	transition frequency	$I_{C} = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	280	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{ I}_{e} = 0; \text{ f} = 1 \text{ MHz}$	-	-	10	pF

Note

1. Pulse test: $t_p \leq 300 \ \mu s; \ \delta \leq 0.02.$

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15 V low V_{CEsat} PNP double transistor

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MLD650

(5)

(6) (7)

(8) (9)

(10)

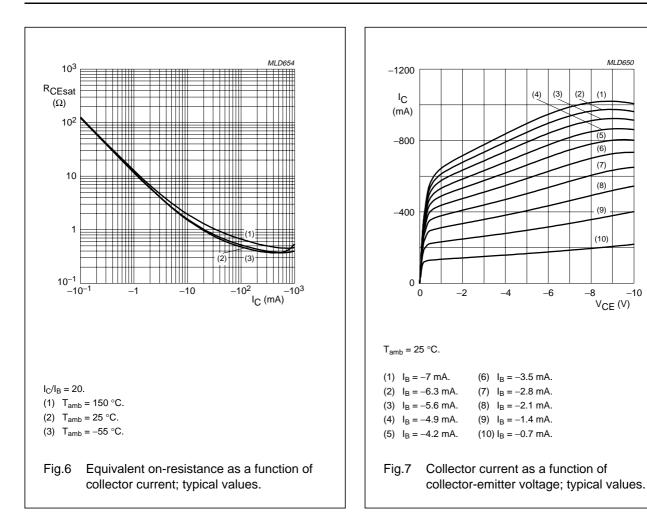
-10 $V_{CE}(V)$

-8

(4) (3) (2) (1)

-4

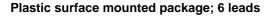
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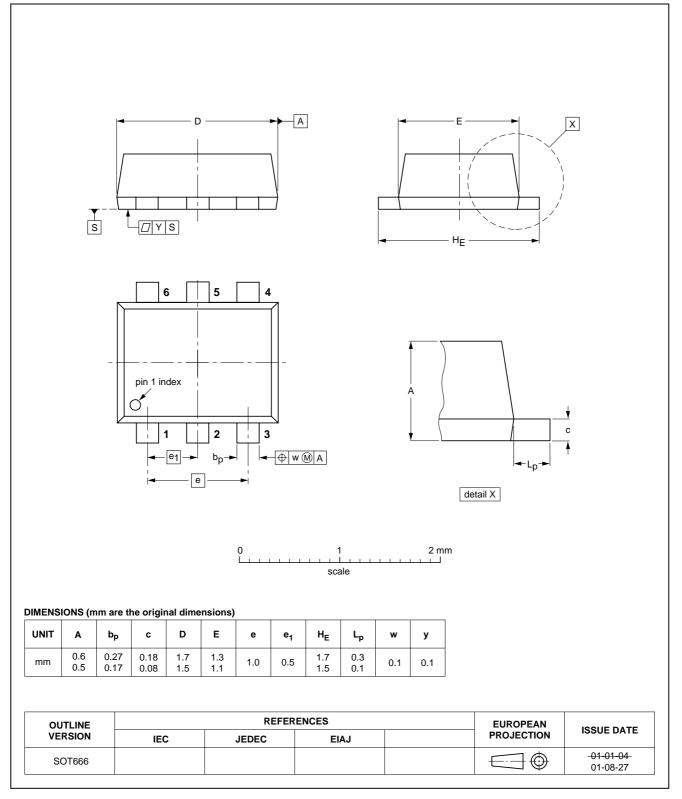


PBSS3515VS

15 V low V_{CEsat} PNP double transistor

PACKAGE OUTLINE





SOT666

15 V low V_{CEsat} PNP double transistor

PBSS3515VS

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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